

# Self-Sensing Test Method for the Temperature of Piezoelectric Stacks

SHEN Xing<sup>1,2</sup>, LI Yang<sup>1,2</sup>, LIANG Lei<sup>1,2\*</sup>, DAI Yuke<sup>1,2</sup>,  
CHEN Yuchen<sup>1,2</sup>, YANG Jinchuan<sup>1,2</sup>

1. State Key Laboratory of Mechanics and Control of Mechanical Structures, Nanjing University of Aeronautics and Astronautics, Nanjing 210016, P. R. China;

2. Low Speed Aerodynamics Institute, China Aerodynamics Research and Development Center, Sichuan 621000, P.R. China

(Received 01 June 2018; revised 19 July 2018; accepted 22 July 2018)

**Abstract:** A self-sensing test method for the temperature of piezoelectric stack, based on the high correlation between the static capacitance and the stack temperature, is proposed in order to construct a self-sufficient methodology of temperature measurement. Firstly, a theoretical model of static capacitance of the piezoelectric stack under preload was set up, and the influence of preload on the static capacitance was analyzed. Secondly, the correctness of the model was verified by static capacitance test experiments under various preloading conditions. Finally, the temperature measurement experiments at low-temperature stage for two kinds of piezoelectric stacks, namely the low-temperature - resistant piezoelectric stack and conventional piezoelectric stack, were conducted under various preloading conditions using a polynomial fitting method. The results, which validate the accuracy of the test method, show that the maximum temperature deviations of the two kinds of piezoelectric stack are 3.9 °C and 2.8 °C, respectively, when the preload force is close to the specified value. The test method uses the piezoelectric stack itself as a temperature sensor, which does not require additional equipment for temperature sensing, so that the space and equipment cost could be economized. And the test for static capacitance is concise and convenient, which indicates that in the cooling process, a concise and efficient test of the temperature of the piezoelectric stack could be realized so as to grasp the current temperature change in time.

**Key words:** temperature test; piezoelectric stack; static capacitance; preload; curve fitting

**CLC number:** TB381; TB941

**Document code:**

**Article ID:** 1005-1120(2019)01-0109-10

## 0 Introduction

Piezoelectric materials, characterized by high electromechanical conversion efficiency, fast response and low power consumption, have been widely used in precision structure actuation, vibration control and noise control, etc.<sup>[1-2]</sup>. Piezoelectric stack that features high force has been increasingly applied to environments with temperature variation, radiation, vacuum, especially in application occasions where the ambient temperature must fall to a low value in recent years<sup>[3-4]</sup>. More example could be given such as active vibration control of the cantilever sting realized by using piezoelectric stack in

the cryogenic wind tunnel<sup>[5-7]</sup>, where the ambient temperature will decline blew  $-150\text{ }^{\circ}\text{C}$  due to liquid nitrogen spray; the piezoelectric stack is used as a force sensor and vibration controller in cryogenic super-conducting cavities<sup>[8]</sup>, the temperature in which shall drop to  $-268.98\text{ }^{\circ}\text{C}$ ; and it is used as a micro displacement positioning actuator in cryogenic optical system, where the piezoelectric stack was subjected to temperature ranging from  $50\text{ }^{\circ}\text{C}$  to  $-130\text{ }^{\circ}\text{C}$ . Both properties and driving characteristics of the piezoelectric stack are vulnerable to the influence of temperature drop<sup>[9-10]</sup>. It is even likely to cause damage or failure of the epoxy resin inside if the piezo-

\*Corresponding author, E-mail address: skywork@163.com

**How to cite this article:** SHEN Xing, LI Yang, LIANG Lei, et al. Self-Sensing Test Method for the Temperature of Piezoelectric Stacks[J]. Transactions of Nanjing University of Aeronautics and Astronautics, 2019, 36(1):109-118.

<http://dx.doi.org/10.16356/j.1005-1120.2019.01.010>

electric stack's temperature exceeds the preset temperature or its own ultimate temperature during the temperature drop. The majority of current researches tends to focus on the effect of temperature variation on the properties of piezoelectric materials such as static capacitance<sup>[11-13]</sup> and impedance<sup>[14-15]</sup>. However, temperature tests based on the fact that properties of piezoelectric materials would vary with temperature were rarely carried out in existing literatures. For instance, Nouroz et al.<sup>[16]</sup> studied the relationship between the impedance of piezoelectric patches and the temperature as well as its own strain, and then concluded that the temperature and strain could simultaneously be determined by impedance test, from 20 °C to 60 °C. The maximum deviation of measured temperature was  $\pm 3.5$  °C. Jürgen et al.<sup>[17]</sup> took independent piezoelectric patches in various types and piezoceramic composites as test objects, its temperature could be similarly determined also by impedance test and the maximum deviation was  $\pm 4.5$  °C from 0 °C to 100 °C. Therefore, test objects of all relevant research have been piezoelectric patches and only the temperature measurement at a high-temperature stage has been realized basically by means of the impedance, which indicates a lack of test statistics and research results on piezoelectric stack at low temperature.

In this paper, a self-sensing test method for the temperature of piezoelectric stack, based on the high correlation between the static capacitance and the stack temperature, is proposed. The corresponding temperature can be calculated by a fitting function after the static capacitance is measured at low-temperature stage. The presented method can be utilized for additionally sensing temperature in devices with integrated piezoelectric stack, and it can save costs and deal with the difficulty in adding additional temperature sensors to the narrow assembly space for piezoelectric stack<sup>[18]</sup>. A rough knowledge of the temperature in the observed object is important information to the user. For example, the exceedance of a certain low temperature limit could be detected easily and avoided timely with the aid of the static capacitance of the piezoelectric stack.

## 1 Theoretical Model for Static Capacitance Under Preload

When an external force acts on the piezoelectric patch, the two electrode plates of the piezoelectric patch will be conferred with electric charges opposite in polarity and equal in electric quantity. Therefore, the piezoelectric patch can be regarded as a plate capacitor with opposite charges accumulated on the two electrode plates and an insulator in the middle. Piezoelectric stack consists of multiple layers of piezoelectric patches with the same electromechanical characteristics combined mechanically in series and electrically in parallel.

According to the equation for calculating parallel-plate capacitance, the capacitance of piezoelectric stack in a free state is expressed as

$$C_f = \frac{n \cdot A \cdot \epsilon_{33}^T}{t} \quad (1)$$

where  $A$  is the cross-sectional area of the piezoelectric stack,  $t$  is the thickness of the piezoelectric patch,  $n$  is the number of piezoelectric patches, and  $\epsilon_{33}^T$  is the dielectric constant in the polarization direction ( $z$ -axis).

Due to the weak resistance to tension of the piezoelectric stack, it is necessary to apply certain compressive preload force  $F_{pre}$  on it by means of external mechanical structure in practice to prevent the stack being exposed to tensile stress. Then, the stack will be subjected to pre-compressive deformation and its output displacement will be reduced when driven. Consequently, a model for the piezoelectric stack under preload is constructed according to the actual situations: the preload force applied to the piezoelectric stack causes a certain degree of deformation  $\Delta L$ . It is assumed that the stiffness of the external mechanical structure is large enough, namely, the piezoelectric stack is completely subjected to the rigid constraint in the polarization direction, which parallel to its length, as shown in Fig. 1. In ideal conditions, the deformation in the polarization direction will remain unchanged even when the piezoelectric stack is driven, and the strain will keep constant as  $\Delta L/L = F_{pre}/kL$ , where  $k$  and  $L$  are the stiffness and original length of the piezoelectric

stack, respectively.

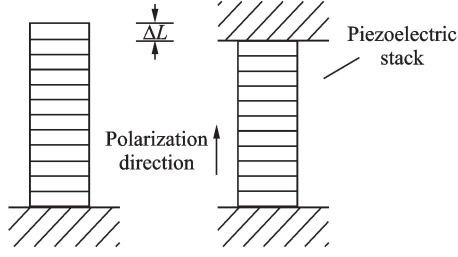


Fig.1 Diagram of piezoelectric stack under preload

Piezoelectric constitutive equations in the polarization direction are as follows<sup>[19]</sup>

$$\begin{aligned} S_3 &= s_{33}^E T_3 + d_{33} E_3 \\ D_3 &= d_{33} T_3 + \epsilon_{33}^T E_3 \end{aligned} \quad (2)$$

where  $S_3$  is the strain,  $T_3$  is the stress,  $D_3$  and  $E_3$  are the electric displacement and electric field in the polarization direction, respectively.

Piezoelectric equations of piezoelectric stack under preload are as follows

$$\frac{F_{\text{pre}}}{k \cdot L} = n \cdot s_{33}^E \cdot T_3 + n \cdot d_{33} \cdot E_3 \quad (3)$$

$Q = n \cdot A \cdot D_3 = n \cdot A \cdot d_{33} \cdot T_3 + n \cdot A \cdot \epsilon_{33}^T \cdot E_3$  (4) where  $s_{33}^E$  and  $d_{33}$  are flexibility coefficient and piezoelectric constant in the polarization direction, respectively. Thus, Eq.(3) can be transformed as follows

$$T_3 = \frac{-d_{33} \cdot E_3}{s_{33}^E} + \frac{F_{\text{pre}}}{k \cdot L} \cdot \frac{1}{n \cdot s_{33}^E} \quad (5)$$

It is assumed that the total quantity of electric charge of the piezoelectric stack is  $Q$  when the testing voltage  $U$  is applied to two electrodes of the piezoelectric stack. Then, the overall capacitance of the piezoelectric stack under preload will be as follows according to the equation of capacitance definition

$$\begin{aligned} C_b &= \frac{Q}{U} = \frac{n \cdot A \cdot D_3}{U} = \\ &= \frac{n \cdot A \cdot (d_{33} \cdot T_3 + \epsilon_{33}^T \cdot E_3)}{U} = \\ &= \frac{n \cdot A \cdot \epsilon_{33}^T \cdot E_3}{U} + \frac{n \cdot A \cdot d_{33} \cdot T_3}{U} = \\ &= \frac{n \cdot A \cdot \epsilon_{33}^T}{t} + \frac{n \cdot A \cdot d_{33} \cdot T_3}{U} \end{aligned} \quad (6)$$

By substituting Eqs.(1), (5) into Eq.(6), the following equation can be obtained.

$$\begin{aligned} C_b &= C_f + \frac{n \cdot A \cdot d_{33}}{U} \cdot \\ &= \left( \frac{-d_{33} \cdot E_3}{s_{33}^E} + \frac{F_{\text{pre}}}{k \cdot L} \cdot \frac{1}{n \cdot s_{33}^E} \right) = \\ &= C_f - \frac{n \cdot A \cdot d_{33}}{U} \cdot \frac{d_{33} \cdot E_3}{s_{33}^E} + \\ &= \frac{n \cdot A \cdot d_{33}}{U} \cdot \frac{F_{\text{pre}}}{k \cdot L} \cdot \frac{1}{n \cdot s_{33}^E} = \\ &= C_f - \frac{n \cdot A \cdot \epsilon_{33}^T}{t} \cdot \frac{d_{33}^2}{\epsilon_{33}^T \cdot s_{33}^E} + \frac{A \cdot d_{33}}{U \cdot s_{33}^E} \cdot \frac{F_{\text{pre}}}{k \cdot L} = \\ &= C_f - C_f \cdot K_{33}^2 + \frac{A \cdot d_{33}}{U \cdot s_{33}^E} \cdot \frac{F_{\text{pre}}}{k \cdot L} = \\ &= (1 - K_{33}^2) \cdot C_f + \Delta C(F_{\text{pre}}) \end{aligned} \quad (7)$$

where  $K_{33}^2 = \frac{d_{33}^2}{\epsilon_{33}^T \cdot s_{33}^E}$  refers to the electromechanical coupling factor, which expresses the efficiency of the electromechanical conversion process. Eq.(7) can be transformed into  $C_b = (1 - K_{33}^2) \cdot C_f$  when only the two ends of stack are fixed and no preload force is applied to it. Since  $K_{33}$  is a value between 0 and 1<sup>[20]</sup>, the coefficient  $(1 - K_{33}^2)$  is also a value between 0 and 1, indicating that the capacitance of piezoelectric stack in fixed state is less than that of the piezoelectric stack in the free state, and the capacitance will increase when the preload force is applied. The increase is defined as

$$\Delta C(F_{\text{pre}}) = \frac{A \cdot d_{33}}{U \cdot s_{33}^E} \cdot \frac{F_{\text{pre}}}{k \cdot L} \quad (8)$$

Within a certain range of temperature drop, a fitting function based on the relationship between the capacitance of piezoelectric stack and the temperature variation under preload can be obtained through the polynomial curve fitting. Then, during the temperature decline, the corresponding temperature can be determined after the capacitance of the piezoelectric stack is tested and substituted into fitting function. According to Eq.(8), the capacitance of the stack will increase under preload force, so the relationship between capacitance and temperature may be different under various preloading conditions, and the increase is correlated with parameters of the piezoelectric stack as well as the preload force applied. As a result, the correctness of the theoretical model needs to be validated through experi-

ments.

## 2 Experiments and Analyses

### 2.1 Experimental apparatus

Two kinds of piezoelectric stacks are employed in the test. One was low-temperature-resistant piezoelectric stack (PSt 150/20), which was subjected to temperature drop from 20 °C to -50 °C in the experiment, the other was conventional piezoelectric stack (PSt 150/VS15), which experienced temperature drop from 20 °C to -20 °C, as shown in Fig. 2.

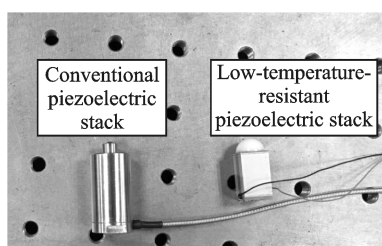


Fig.2 Two kinds of piezoelectric stacks

The experimental setup for applying mechanical loads to piezoelectric stack was designed and manufactured, as shown in Fig. 3. The piezoelectric stack was installed on the pressure sensor and clamped between the upper and the lower disks that were connected through four bolts. Different preload forces, measured by a pressure sensor, could be applied to the piezoelectric stack by adjusting the preload nuts on the bolts. In all cases, the compressive stress was parallel to the polarization direction. Thermistor temperature sensor was connected to the stack, whose actual temperature was measured.

The experimental setup was placed in a low-temperature test chamber. The displays of both the pressure sensor and temperature sensor were placed outside the test chamber. The data cable connected the internal sensor with the external display instrument through the hole at the side of the test chamber. Similarly, the coaxial cable of the piezoelectric stack was also left outside the chamber and linked with LCR testing instrument, which is feasible to test inductance, capacitance and resistance, so as to measure the capacitance of the stack directly, as

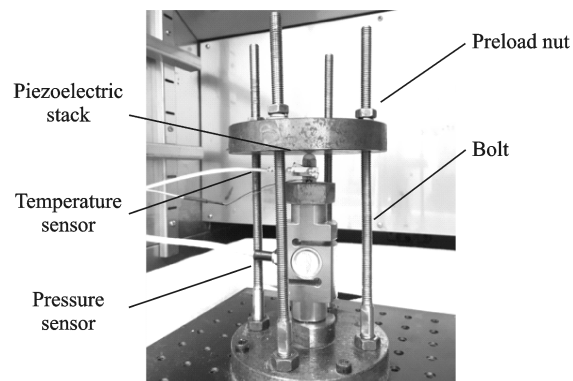


Fig.3 Experimental setup for applying mechanical loads to piezoelectric stacks

shown in Fig.4. Among them, the testing voltage of LCR instrument was 150 mV, and the testing frequency was 100 Hz, which was far below 50 kHz, the resonant frequency of piezoelectric stack. Therefore, the measured capacitance is static. In the experiment, a low-temperature pressure sensor (LKL-102L-type); a thermal resistance temperature sensor (WZP); an LCR testing instrument (VICTOR 6243-type), and a low-temperature test chamber (HRH0270-type) were adopted.

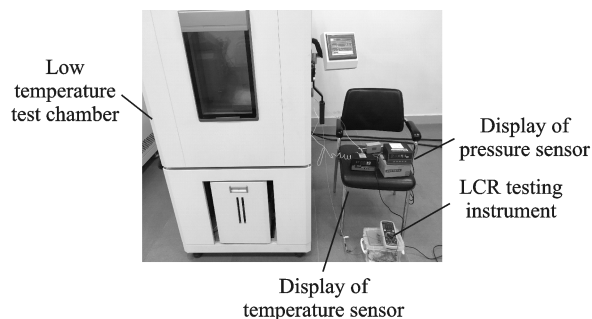


Fig.4 Photograph of the experimental device

### 2.2 Experiments on the effect of preload force on static capacitance

#### 2.2.1 Experimental scheme

Experiments of the static capacitance variation with the temperature for the two kinds of piezoelectric stacks in the free state have been conducted. The cooling rate of the low-temperature chamber was 2 °C/min, and the capacitance was measured at every 3 °C interval during the temperature decline. Then, the static capacitance-temperature relationship curves were obtained, and two fitting functions

for the piezoelectric stacks were derived via curve fitting based on the quadratic polynomial model, as shown in Fig. 5. The correlation coefficient of the fitting result  $R^2$ , has turned out to be larger than 0.99 in both experiments, indicating that there is a high correlation between the static capacitance and temperature.

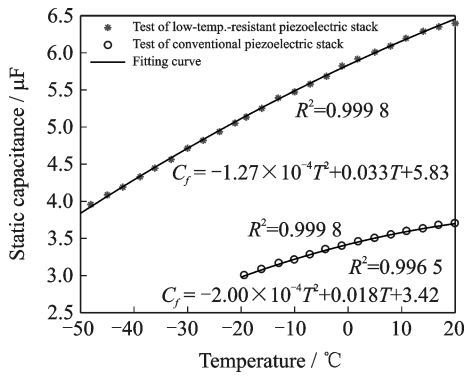


Fig.5 Curve-fitting results of static capacitance of two kinds of piezoelectric stacks varying with temperature in free state

After that, at room temperature of 20 °C, preload forces of 870 N and 320 N were applied to the low-temperature-resistant piezoelectric stack and conventional piezoelectric stack, respectively. Then similar experiments were also conducted. Thus, the experimental results illustrating the temperature variation with the static capacitance of the two piezoelectric stacks under preload were obtained.

### 2.2.2 Verification experiments results on the low-temperature-resistant piezoelectric stack

Relevant parameters of two kinds of piezoelectric stacks provided by the manufacturer are shown in Table 1. Besides, Refs. [21-22] shows that the measurement of the electromechanical coupling factor of piezoelectric ceramics  $K_{33}$ , basically remains constant within the range from room temperature to -50 °C. To facilitate the calculation, it is assumed that the values of  $K_{33}$  of both piezoelectric stacks are constant.

Table 1 Parameters of two kinds of piezoelectric stacks

Parameter	Low-temperature-resistant piezoelectric stack	Conventional piezoelectric stack
Stiffness $k/(N \cdot m^{-1})$	$3.40 \times 10^8$	$1.70 \times 10^8$
Sectional area $A/m^2$	$1.00 \times 10^{-4}$	$1.33 \times 10^{-4}$
Length $L/m$	$1.80 \times 10^{-2}$	$2.80 \times 10^{-2}$
Preload force $F_{pre}/N$	870	320
Relative dielectric constant $\epsilon_{rel}$		5 400
Piezoelectric constant $d_{33}/(m \cdot V^{-1})$		$6.35 \times 10^{-10}$
Flexibility coefficient $s_{33}^E/(m^2 \cdot N^{-1})$		$1.81 \times 10^{-11}$
Electromechanical coupling factors $K_{33}$		0.68
Testing voltage $U/V$		$1.50 \times 10^{-1}$

The increase in capacitance, which could be calculated by the equation  $\Delta C(F_{pre}) = 3.32 \mu F$ , was obtained by substituting parameters of low-temperature-resistant piezoelectric stack in Table 1 into Eq. (8). By substituting them into Eq.(7) with the capacitance-temperature fitting function in the free state, the theoretical capacitance-temperature relationship under preload can be obtained.

$$C_b = (1 - 0.68^2) \cdot (-1.27 \times 10^{-4} \cdot T^2 + 0.033 \cdot T + 5.83) + 3.32$$

The theoretical results are plotted and then con-

trasted with the experimental results, as shown in Fig. 6.

The results show that, with a preload force of 870 N, the static capacitance increases to some extent and the static capacitance-temperature curve moves upward as a whole, which is consistent with the theoretical analysis in Section 1. Moreover, at the temperature of 20 °C, the experimental value of capacitance is 6.69  $\mu F$  with the theoretical value being 6.79  $\mu F$ , which means there is a deviation of 1.5% between the two values. However, as the

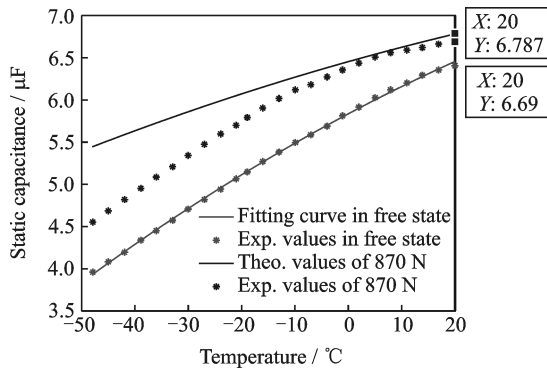


Fig.6 Comparison of theoretical and experimental values of capacitance - temperature relationship of the low-temperature-resistant piezoelectric stack under preload

temperature decreases, the deviation between experimental and theoretical values increases gradually.

### 2.2.3 Verification experiments results on the conventional piezoelectric stack

The increase in capacitance  $\Delta C(F_{pre}) = 2.08 \mu\text{F}$ , which can be calculated by the substitution of parameters of conventional piezoelectric stack in Table 1 into Eq.(8). The way to obtain the theoretical capacitance - temperature relationship under preload is the same as that of low - temperature - resistant piezoelectric stack experiment, and the result is

$$C_b = (1 - 0.68^2) \cdot (-2 \times 10^{-4} \cdot T^2 + 0.018 \cdot T + 3.42) + 2.08$$

The theoretical results are plotted and contrasted with the experimental results, as shown in Fig. 7.

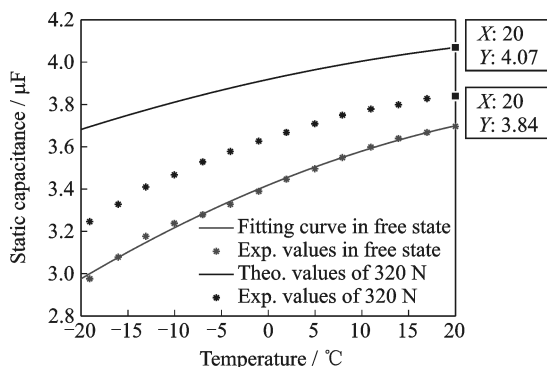


Fig.7 Comparison of theoretical and experimental values of capacitance - temperature relationship of the conventional piezoelectric stack under preload

The results show that, with a preload force of 320 N, the static capacitance-temperature curve also deflects upwards as a whole, which is in accor-

dance with the theoretical analysis in Section 1. Besides, at the temperature of 20 °C, the experimental value of capacitance is 3.84  $\mu\text{F}$  and the theoretical value is 4.07  $\mu\text{F}$ , so the deviation is 5.7%.

Through experiments, the hypothesis that preload force can increase static capacitance of the piezoelectric stack has been verified, and the deviation turns out to be relatively small compared with theoretical results, which has demonstrated the correctness of the theoretical model in Section 1. From Figs. 6, 7, however, both comparison results of two piezoelectric stacks have shown that the deviation would increase gradually with the temperature drop, and theoretical values are larger than experimental values in general. The reason lies in that the electromechanical coupling factor  $K_{33}$  has been set as constant in the theoretical calculation, while  $K_{33}$  would increase with the temperature drop and the augment of preload force in practical experiments. Eq.(7) can be transformed as shown below to facilitate the analysis and explain.

$$C_b = (1 - K_{33}^2) \cdot C_f + \Delta C(F_{pre}) = C_f - C_f \cdot K_{33}^2(T, F_{pre}) + \Delta C(F_{pre}) \quad (9)$$

In addition, the deviation of the conventional piezoelectric stack at 20 °C is relatively larger than that of low-temperature-resistant piezoelectric stack. It is because the conventional piezoelectric stack in Fig. 2 is a kind of encapsulation structure, which means its internal pretension springs would provide an extra preload force in addition to the external preload force.

## 2.3 Temperature measurement experiments based on static capacitance

### 2.3.1 Experimental scheme

In addition to the temperature, the static capacitance of the piezoelectric stack can also be changed with the preload force according to the analysis above. Consequently it is necessary to test the relationship between the capacitance and temperature of the two piezoelectric stacks under various preloads to investigate the temperature measurement effects of the test method under different preloading conditions.

According to the manufacturers, it is specified



that the preload force should be set to around one-tenth of the blocking force to ensure maximal life-time. Since the blocking force of the low-temperature-resistant piezoelectric stack is 7 000 N. Therefore, four preload forces, i.e., 650 N, 700 N (the specified value), 750 N, and 870 N, have been applied respectively at room temperature of 20 °C. The blocking force of the conventional piezoelectric stack is 2 300 N, and three preload forces, 230 N (the specified value), 280 N, 330 N, have been applied at the same room temperature, respectively. Firstly, the corresponding static capacitance under different preloading conditions was measured as the initial value  $C_0$ . Similarly, during the temperature decline at the rate of 2 °C/min, the capacitance  $C_b$  was measured at every 3 °C interval, and the capacitance variation was calculated through equation  $\Delta C_b = C_b - C_0$ . Thus, the capacitance variation-temperature relationship curves of the two piezoelectric stacks under different preloading conditions were obtained.

### 2.3.2 Temperature measurement results of the low-temperature-resistant piezoelectric stack and discussion

The capacitance variation-temperature relationship curves of the low-temperature-resistant piezoelectric stack are shown in Fig. 8. The results indicate that the curves will move up resulting from the decrease of the capacitance variation when the preload force increases. Moreover, there is a small non-linear area at the initial stage of temperature decline, after which the curves keep a quasi-linear relation.

The capacitance variation-temperature curve under specified preload force of 700 N was then fitted to obtain a quadratic polynomial fitting function

$$T = 2.42 \times \Delta C_b^2 + 30.85 \times \Delta C_b + 17.29$$

The capacitance variation under the other three preload forces was tested and substituted into the fitting function to calculate the estimated temperature. Then it was compared with the actual measured temperature to obtain the deviation at every temperature points, as shown in Fig. 9.

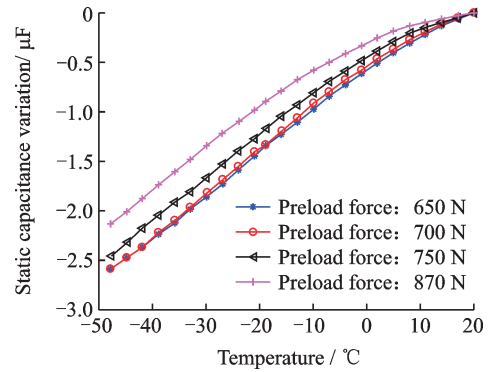


Fig. 8 Capacitance variation-temperature relationship of the low-temperature-resistant piezoelectric stack under different preloading conditions

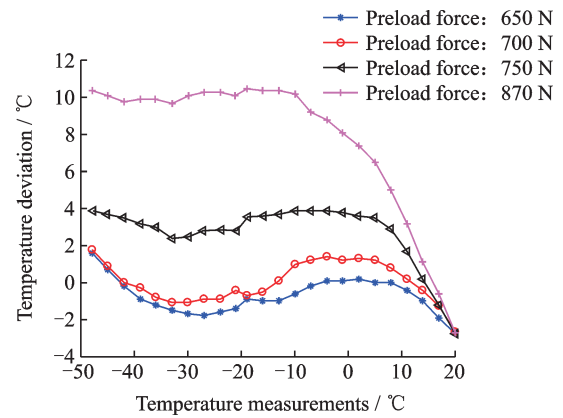


Fig. 9 Temperature deviation of low-temperature-resistant piezoelectric stack under different preloading conditions

The maximum deviation and the average deviation were calculated within the temperature measurement range, as shown in Table 2. The results show that the maximum deviation is 3.9 °C and the average deviation is lower than 3 °C in a range from 650 N to 750 N of the preload force. Furthermore, the maximum deviation value is 10.5 °C and the average deviation value is 8.1 °C when the preload force is 870 N. Therefore, it indicates that the deviation of temperature measurement is relatively insignificant in the range of 650 N to 750 N, namely, being close to the specified preload force of 700 N. The deviation is relatively large under the condition of excessive preload force. The reason lies in that the curves of capacitance variation over temperature will move up when the preload force increases. Hence, excessive preload force can increase the gap between curves, thereby causing greater deviation.

**Table 2** Experimental results of low-temperature-resistant piezoelectric stack under different preloading conditions

Preload force/N	Average deviation/°C	Maximum deviation/°C
650	1.0	-2.7
700	0.9	-2.7
750	3.0	3.9
870	8.1	10.5

### 2.3.3 Temperature measurement results of the conventional piezoelectric stack and discussion

The capacitance variation-temperature relationship curves of the conventional piezoelectric stack are shown in Fig. 10. The results also indicate that the curves will move up when the preload force increases.

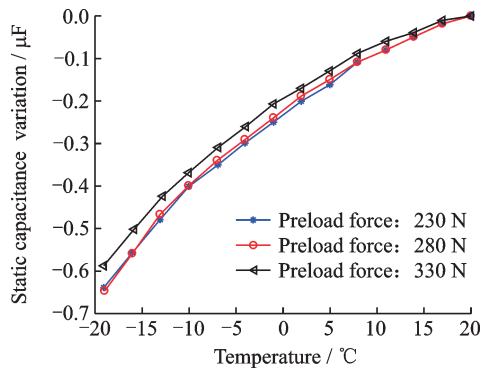


Fig. 10 Capacitance variation - temperature relationship of the conventional piezoelectric stack under different preloading conditions

The capacitance variation - temperature curve under specified preload force of 230 N was fitted to obtain a quadratic polynomial fitting function

$$T = 56.13 \times \Delta C_b^2 + 94.06 \times \Delta C_b + 18.77$$

The capacitance variation under the other two preload forces were tested and substituted into the fitting function respectively to calculate the estimated temperature, the deviation was obtained in the same way as described above for low-temperature-resistant piezoelectric stack, as shown in Fig. 11.

The maximum deviation and the average deviation were calculated within the temperature measurement range, as shown in Table 3. The results

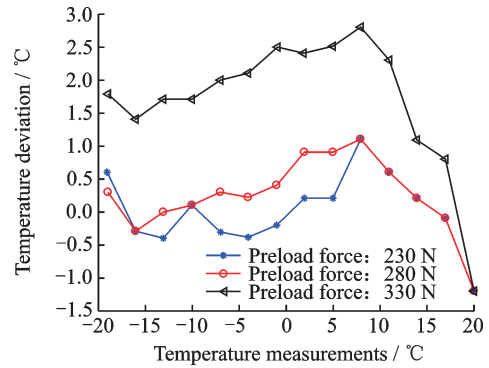


Fig. 11 Temperature deviation value of conventional piezoelectric stack under different preloading conditions

show that the maximum deviation is 2.9 °C and the average deviation is lower than 2 °C in a range of 230 N to 330 N of the preload force, which indicates that the deviation of temperature measurement is relatively insignificant in the range of 230 N to 330 N, namely, when it is close to the specified preload force of 230 N.

**Table 3** Experimental results of conventional piezoelectric stack under different preloading conditions

Preload force/N	Average deviation/°C	Maximum deviation/°C
230	0.4	-1.2
280	0.5	-1.2
330	1.9	2.8

## 3 Conclusions

A self-sensing temperature test method was proposed based on the measurement of temperature-dependent capacitance changes of piezoelectric stack. In addition, a theoretical model for static capacitance under preload has been established, which facilitates the analysis of the influence of preload force on static capacitance and the validation of the model's correctness through experiments. Moreover, temperature measurement experiments on the two piezoelectric stacks under various preloading conditions were conducted to prove the feasibility of the test method. The experimental results show that the maximum deviation is 3.9 °C and the average deviation is lower than 3 °C in a preload force range of 650 N to 750 N for low-temperature-resistant piezoelectric stack; and for the conventional piezoelectric



stack, the maximum deviation is 2.8 °C and the average deviation is lower than 2 °C over a preload force range of 230 N to 330 N, which indicates that the deviation of temperature measurement is smaller when it is close to the specified preload force.

The attraction of such a method is that no additional temperature sensor is needed, because the piezoelectric stack can be used as temperature sensors. It is simple and convenient to enhance the experimenter's awareness of the current temperature of piezoelectric stack, which is significant and valuable in taking timely temperature control measures to protect the piezoelectric stack.

### References

- [1] XING X, GUO M, CHEN J, et al. A piezoelectric friction-inertial linear motor based on piezoelectric single-crystal cymbal displacement amplification mechanism[J]. Transactions of Nanjing University of Aeronautics and Astronautics, 2017, 34(1): 55-61.
- [2] WANG L W, XIA P Q. Active vibration isolation of helicopter by using piezoelectric stack actuators installed on struts of main Gearbox[J]. Journal of Nanjing University of Aeronautics and Astronautics, 2018, 50(2): 233-238. (in Chinese)
- [3] ZHANG X, ZHAO G F, PAN M. The research of piezoelectric actuator for cryogenic scanning application [J]. Proceedings of SPIE, 2011, 8193: 819332-1-819332-7.
- [4] HAN C, JEON J, CHUNG J U, et al. Dynamic characteristics and control capability of a piezostack actuator at high temperatures: experimental investigation [J]. Smart Materials & Structures, 2015, 24(5): 57-59.
- [5] FEHREN H, GNAUERT U, WIMMEL R, et al. Validation testing with the active damping system in the European Transonic Wind tunnel [C]//39th AIAA Aerospace Sciences Meeting and Exhibit. Reno: AIAA, 2001: 610.
- [6] BALAKRISHNA S, BUTLER D, WHITE E, et al. Active damping of sting vibrations in transonic wind tunnel testing [C]//46th AIAA Aerospace Sciences Meeting and Exhibit. USA: AIAA, 2008: 840.
- [7] BALAKRISHNA S, BUTLER D, ACHESON M, et al. Design and performance of an active sting damper for the NASA common research model[C]//49th AIAA Aerospace Sciences Meeting Including the New Horizons Forum and Aerospace Exposition. Orlando: AIAA, 2011: 953.
- [8] FOUAIDY M, MARTINET G, HAMMOUDI N. Low temperature electromechanical and dynamic properties of piezostacks for superconducting RF cavities fast tuners [J]. Tidsskrift for Den Norske Legeforening, 2006, 102(102): 359-364.
- [9] JIN J, ZHANG J, ZHAO C. Principle of a new type of ultrasonic motor rotating around multi-axis[J]. Journal of Vibration, Measurement & Diagnosis, 2008, 28(4): 369-372.
- [10] CHEN R N, CHEN Z. Recent development of ultrasonic motors[J]. Journal of Vibration, Measurement & Diagnosis, 2002, 22(4): 270-276.
- [11] BALMES E, GUSKOV M, REBILLAT M, et al. Effects of temperature on the impedance of piezoelectric actuators used for SHM [C]//14th Symposium on Vibration, Shock and Noise (VISHNO). France: SAM, 2014: 1-6.
- [12] SEPEHRY N, SHAMSHIRSAZ M, BASTANI A. Experimental and theoretical analysis in impedance-based structural health monitoring with varying temperature[J]. Structural Health Monitoring, 2010, 10(6): 573-585.
- [13] GRISSO B L, INMAN D J. Temperature corrected sensor diagnostics for impedance-based SHM[J]. Journal of Sound & Vibration, 2010, 329(12): 2323-2336.
- [14] QIU Z, SADIQ M R, DEMORE C, et al. Characterization of piezocrystals for practical configurations with temperature- and pressure-dependent electrical impedance spectroscopy [J]. IEEE Transactions on Ultrasonics Ferroelectrics & Frequency Control, 2011, 58(9): 1793-1803.
- [15] GUBINYI Z, BATUR C, SAYIR A, et al. Electrical properties of PZT piezoelectric ceramic at high temperatures [J]. Journal of Electroceramics, 2008, 20(2): 95-105.
- [16] ISLAM M N, SEETHALER R, ALAM M S. Characterization of piezoelectric materials for simultaneous strain and temperature sensing for ultra-low frequency applications[J]. Smart Materials & Structures, 2015, 24(8): 085019-085026.
- [17] ILG J, RUPITSCH S J, LERCH R. Impedance-based temperature sensing with piezoceramic devices [J]. IEEE Sensors Journal, 2013, 13(6):2442-2449.
- [18] ISLAM M N, SEETHALER R J. An improved electromechanical model and parameter identification technique for piezoelectric actuators[J]. Journal of Intelligent Material Systems & Structures, 2013, 24(9): 1049-1058.

- [19] IEEE. ANSI/IEEE Std. 176-1987, IEEE Standard on Piezoelectrics[S]. USA: IEEE, 1987.
- [20] LEO D J. Engineering analysis of smart material systems[M]. John Wiley & Sons, 2008.
- [21] SABAT R G, MUKHERJEE B K, REN W, et al. Temperature dependence of the complete material coefficients matrix of soft and hard doped piezoelectric lead zirconate titanate ceramics[J]. Journal of Applied Physics, 2007, 101(6):121-126.
- [22] RUPITSCH S J, ILG J. Complete characterization of piezoceramic materials by means of two block-shaped test samples [J]. IEEE Trans Ultrason Ferroelectr Freq Control, 2015, 62(7):1403-1413.

**Acknowledgements** This work is supported by the \* Mechanism Study on Adaptive Wings, the 13th Five-Year Plan of AAF Army Air Forcepre-Research, the Postgraduate Research & Practice Innovation Program of Jiangsu Province (No. KYCX18\_0266), and the Fundamental Research Funds for the Central Universities (No.kfjj20180105).

**Authors** Prof. SHEN Xing received the Ph. D. degree from Nanjing University of Aeronautics and Astronautics in 2003. He is now a professor at Nanjing University of Aeronautics and Astronautics. His research interests focus on aeronautical smart structure, which includes design and test of the piezoelectric ceramics, piezoelectric sensors and actuators and relative research in the smart material structure.

Mr. LI Yang received the M.S. degree in measurement and control technology and instrument from China Jiliang University, Hangzhou, China, in 2016. He is currently a Ph.D. candidate at Nanjing University of Aeronautics and Astronautics, Nanjing, China. His main research field is smart materials and structures.

Mr. LIANG Lei received the M. S. degree from National University of Defense Technology in 2004. He is now an associate professor at China Aerodynamics Research and De-

velopment Center. His research interests focus on Flow Visualization and Measurement, which includes particle image velocimetry, pressure sensitive paint, strain gauge calibration, and smart structure, etc.

Mr. DAI Yuke received the bachelor degree in aircraft design from Nanjing University of Aeronautics and Astronautics, Nanjing, China, in 2017, and he joined the State Key Laboratory of Mechanics and Control of Mechanical Structures as a postgraduate student. His main research field is smart material and structure.

Ms. CHEN Yuchen received the Engineer Degree (Diplôme d'Ingénieur) in scientific instrumentation from École Polytechnique Universitaire de Lille, France, and she joined the State Key Laboratory of Mechanics and Control of Mechanical Structures as a Ph.D. candidate. Her main research domain is smart material structure engineering in aeronautics.

Mr. YANG Jinchuan received the B.S. degree in aeronautics design from Nanjing University of Aeronautics and Astronautics, Nanjing, China, in 2017, and he joined the State Key Laboratory of Mechanics and Control of Mechanical Structures as a postgraduate student. His main research is smart material structure and control.

**Author contributions** Prof. SHEN Xing and Dr. LIANG Lei designed the study, compiled the models and revised the manuscript. Mr. LI Yang performed the experiments, conducted the analysis, interpreted the results and wrote the manuscript. Mr. DAI Yuke, Ms. CHEN Yuchen and Mr. YANG Jinchuan assisted with experimental design and data interpretation. All authors commented on the manuscript draft and approved the final manuscript.

**Competing interests** The authors declare no competing interests.

(Production Editor: Zhang Tong)